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APPLICATION NO. FILING DATE		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/707,396		12/10/2003	Ching-Nan Hsiao	NTCP0020USA	1395	
27765	7590	05/11/2005		EXAMINER		
		ICA INTERNATIO	GEBREMARIAM, SAMUEL A			
	P.O. BOX 506 MERRIFIELD, VA 22116				PAPER NUMBER	
	·			2811		
				DATE MAILED: 05/11/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)		
10/707,396	CHING-NAN HSIAO		
Examiner	Art Unit		
Samuel A. Gebremariam	2811		

•	LAdillilei	Account	
	Samuel A. Gebremariam	2811	
The MAILING DATE of this communication appe	ears on the cover sheet with the o	correspondence add	ress
THE REPLY FILED <u>22 April 2005</u> FAILS TO PLACE THIS APF	PLICATION IN CONDITION FOR A	LLOWANCE.	
1. The reply was filed after a final rejection, but prior to or or this application, applicant must timely file one of the follow places the application in condition for allowance; (2) a Not a Request for Continued Examination (RCE) in compliantime periods:	wing replies: (1) an amendment, af otice of Appeal (with appeal fee) in	fidavit, or other evider compliance with 37 C	nce, which FR 41.31; or (3)
a) The period for reply expires 3 months from the mailing date	-		iahawaa ia tataa In
b) The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire	ater than SIX MONTHS from the mailin	g date of the final rejecti	on.
Examiner Note: If box 1 is checked, check either box (a) or TWO MONTHS OF THE FINAL REJECTION. See MPEP 7	06.07(f).		
Extensions of time may be obtained under 37 CFR 1.136(a). The date have been filed is the date for purposes of determining the period of exunder 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set forth in (b) above, if checked. Any reply received by the Office late may reduce any earned patent term adjustment. See 37 CFR 1.704(b)	ctension and the corresponding amount shortened statutory period for reply orig r than three months after the mailing da	of the fee. The appropr jinally set in the final Offi	iate extension fee ce action; or (2) as
NOTICE OF APPEAL	-11	Eland	
<ol> <li>The Notice of Appeal was filed on A brief in comfiling the Notice of Appeal (37 CFR 41.37(a)), or any external a Notice of Appeal has been filed, any reply must be filed.</li> </ol>	ension thereof (37 CFR 41.37(e)), to	o avoid dismissal of th	ns of the date of the appeal. Since
AMENDMENTS			
<ol> <li>The proposed amendment(s) filed after a final rejection,</li> <li>(a) They raise new issues that would require further compared to the first proposed amendment (s).</li> </ol>			ecause
(b) They raise the issue of new matter (see NOTE bek		TE below),	
(c) They are not deemed to place the application in be appeal; and/or		educing or simplifying	the issues for
(d) They present additional claims without canceling a		jected claims.	
NOTE: (See 37 CFR 1.116 and 41.33(a))			(DTOL 004)
4. The amendments are not in compliance with 37 CFR 1.1		ompliant Amendment	(P10L-324).
<ul><li>5. Applicant's reply has overcome the following rejection(s</li><li>6. Newly proposed or amended claim(s) would be a</li></ul>		timely filed amendme	ant cancaling the
non-allowable claim(s).	•		
7.  For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is pro The status of the claim(s) is (or will be) as follows:		ill be entered and an	explanation of
Claim(s) allowed:			
Claim(s) objected to:		·	
Claim(s) rejected:			
Claim(s) withdrawn from consideration:  AFFIDAVIT OR OTHER EVIDENCE			
8. The affidavit or other evidence filed after a final action, be because applicant failed to provide a showing of good ar was not earlier presented. See 37 CFR 1.116(e).	nd sufficient reasons why the affida	vit or other evidence i	s necessary and
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to showing a good and sufficient reasons why it is necessar	overcome <u>all</u> rejections under appe ry and was not earlier presented. S	eal and/or appellant fa See 37 CFR 41.33(d)(	ils to provide a 1).
10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER	on of the status of the claims after e	entry is below or attac	hed.
11.   The request for reconsideration has been considered by See Continuation Sheet.	ut does NOT place the application i	in condition for allowa	nce because:
12. Note the attached Information Disclosure Statement(s).	(PTO/SB/08 or PTO-1449) Paper J	<b>y</b> 6(s). <b>//</b>	)
13.	(		
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Continuation of 11. does NOT place the application in condition for allowance because: Applicant argues that the office action fails to show motivation to combine the reference by Mandelman and Nitayama. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See In re Fine, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988)and In re Jones, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, as indicated in the last office action, Mandelman does not explicitly teach a shallow trench isolation (STI) positioned around the deep trench; the gate conductive layer is electrically connected to a first contact plug and the annular drain being electrically connected to a second contact plug and the annular trench positioned next to the STI and the annular drains of adjacent vertical transistors isolated from each other by the STI. However it is conventional and also taught by Nitayama (figs. 4A and 4B) forming contact structure (112) on a gate conductive layer (124) and also making contact structure (106) on a drain region (134) in order to make contact to other portion of an integrated circuit device. Nitayama also teaches in (fig. 4B) the use of STI structures (108) positioned around deep trenches (110).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to incorrporate the gate and drain contacts in the structure taught by Nitayama in the structure of Mandelman in order to make contact to other portion of the integrate circuit. Furthermore it would have been obvious to one of ordinary skill in the art at the time the invention was made to incorporate the STI structure taught by Nitayama in the structure of Mandelman in order to provide better isolation. The modified structure of Mandelman and Nitayama would have an STI around the deep trench and annular drains of adjacent vertical transistors isolated from each other by the STI.